



DMPH4023SK3Q

40V 175°C P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BV _{DSS} | R _{DS(ON)} max | I _D max T _C = +25°C |
|-------------------|-------------------------|--|
| -40V | 26mΩ @ V_{GS} = -10V | -50A |

Features

- Rated to +175°C—Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

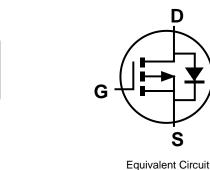
- Motor Control
- Backlighting
- DC-DC Converters
- Printer Equipment



Top View

Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)



Ordering Information (Note 5)

| Part Number | Case | Packaging |
|-----------------|--------------|------------------|
| DMPH4023SK3Q-13 | TO252 (DPAK) | 2500/Tape & Reel |

D

U D

Pin Out

Top View

S

G

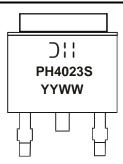
Notes:

EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, see https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



) | | = Manufacturer's Marking PH4023S = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|---|--|------------------|------------|----|
| Drain-Source Voltage | | V _{DSS} | -40 | V |
| Gate-Source Voltage | | V _{GSS} | ±20 | V |
| Continuous Drain Current (Note 7) V_{GS} = -10V | $T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$ | Ι _D | -50 -35 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | I _{DM} | -70 | A |
| Maximum Continuous Body Diode Forward Current (Note 7) | | Is | -4 | A |
| Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%) | | I _{SM} | -70 | A |
| Avalanche Current, L = 0.1mH (Note 8) | | IAS | -40 | A |
| Avalanche Energy, L = 0.1mH (Note 8) | | E _{AS} | 85 | mJ |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|--|--------------|-----------------------------------|-------------|------|--|
| Total Power Dissipation (Note 6) | | PD | 2.1 | W | |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | R _{OJA} | 71 | °C/W | |
| Total Power Dissipation (Note 7) | | PD | 3.6 | W | |
| Thermal Resistance, Junction to Ambient (Note 7) | Steady State | R _{0JA} | 41 | °C/W | |
| Thermal Resistance, Junction to Case | | R _{eJC} | 1.5 | C/W | |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +175 | °C | |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

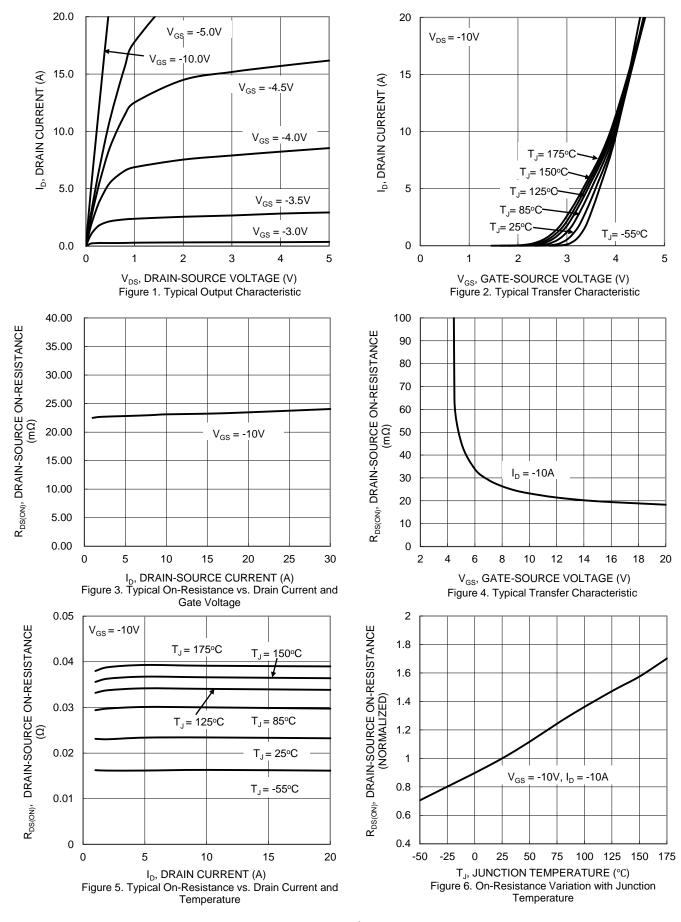
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|-----------------------------------|---------------------|-----|-------|-------|------|---|--|
| OFF CHARACTERISTICS (Note 9) | Symbol | | тур | IVIAX | Unit | Test condition | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -40 | | _ | V | $V_{GS} = 0V, I_{D} = -250 \mu A$ | |
| Zero Gate Voltage Drain Current | IDSS | | | -1 | μA | $V_{DS} = -40V, V_{GS} = 0V$ | |
| Gate-Source Leakage | IGSS | | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 9) | | | | • | | · | |
| Gate Threshold Voltage | V _{GS(TH)} | -1 | _ | -3 | V | $V_{DS} = V_{GS}, I_D = -250 \mu A$ | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | _ | 21 | 26 | mΩ | $V_{GS} = -10V, I_D = -10A$ | |
| Diode Forward Voltage | V _{SD} | _ | -0.75 | -1.2 | V | $V_{GS} = 0V, I_{S} = -1A$ | |
| DYNAMIC CHARACTERISTICS (Note 10) | | | | | | | |
| Input Capacitance | Ciss | _ | 1091 | _ | рF | | |
| Output Capacitance | Coss | | 288 | — | pF | − V _{DS} = -20V, V _{GS} = 0V, − f = 1MHz | |
| Reverse Transfer Capacitance | C _{rss} | | 111 | _ | pF | | |
| Gate Resistance | Rg | _ | 14 | — | Ω | V_{DS} = 0V, V_{GS} = 0V, f = 1MHz | |
| Total Gate Charge | Qg | — | 18.7 | _ | nC | V _{DS} = -20V, I _D = -10A, | |
| Gate-Source Charge | Q _{gs} | _ | 4.2 | — | nC | 50 / 5 / | |
| Gate-Drain Charge | Q _{gd} | _ | 5.0 | — | nC | V _{GS} = -10V | |
| Turn-On Delay Time | t _{D(ON)} | | 5.3 | _ | ns | | |
| Turn-On Rise Time | t _R | | 4.8 | — | ns | V _{DD} = -20V, V _{GS} = -10V, | |
| Turn-Off Delay Time | t _{D(OFF)} | | 30.7 | — | ns | $R_G = 6\Omega$, $I_D = -10A$ | |
| Turn-Off Fall Time | t _F | | 23.4 | _ | ns | | |
| Reverse Recovery Time | t _{RR} | | 17.8 | _ | ns | | |
| Reverse Recovery Charge | Q _{RR} | | 9.2 | _ | nC | I _F = -10A, di/dt = -100A/μs | |

6. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout. Notes:

7. Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.

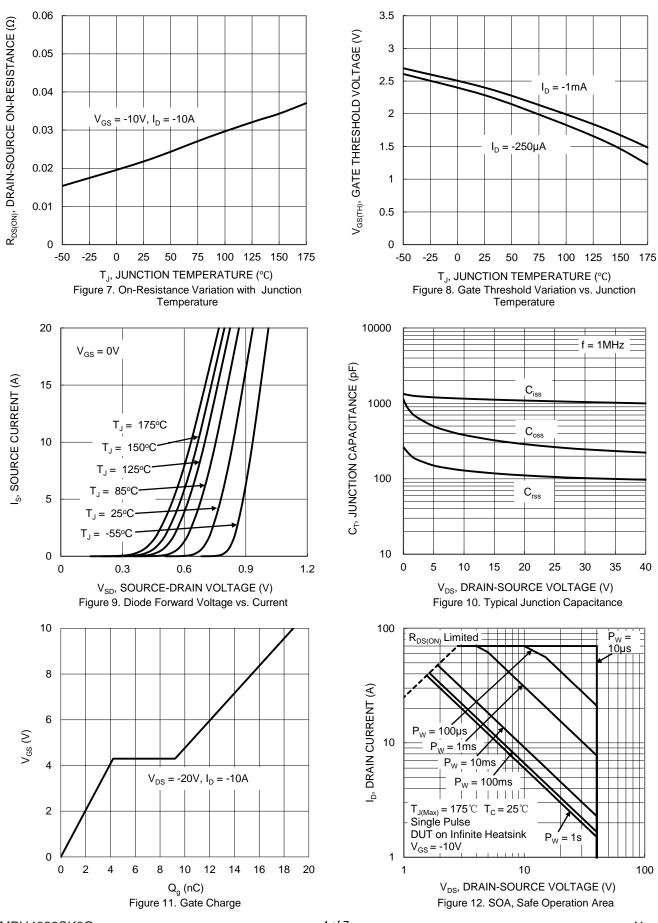
8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}$ C. 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



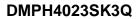


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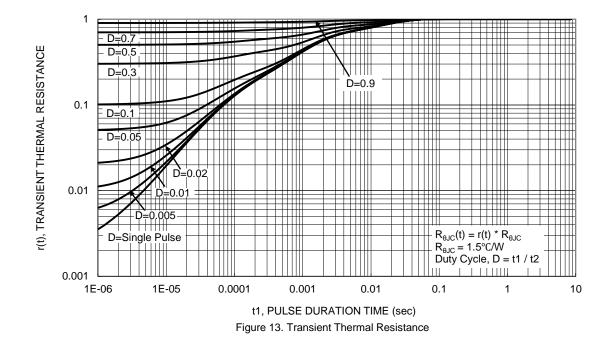




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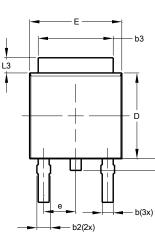


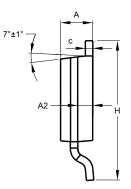


Package Outline Dimensions

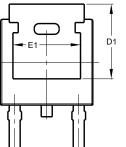
Please see http://www.diodes.com/package-outlines.html for the latest version.

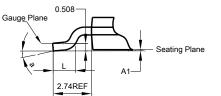
L4





TO252 (DPAK)

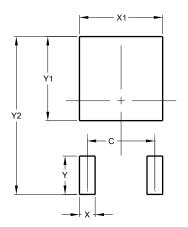




| TO252 (DPAK) | | | | | | |
|--------------|----------------------|-------|-------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 2.19 | 2.39 | 2.29 | | | |
| A1 | 0.00 | 0.13 | 0.08 | | | |
| A2 | 0.97 | 1.17 | 1.07 | | | |
| b | 0.64 | 0.88 | 0.783 | | | |
| b2 | 0.76 | 1.14 | 0.95 | | | |
| b3 | 5.21 | 5.46 | 5.33 | | | |
| c | 0.45 | 0.58 | 0.531 | | | |
| D | 6.00 | 6.20 | 6.10 | | | |
| D1 | 5.21 | - | - | | | |
| е | - | - | 2.286 | | | |
| Ε | 6.45 | 6.70 | 6.58 | | | |
| E1 | 4.32 | - | - | | | |
| Н | 9.40 | 10.41 | 9.91 | | | |
| ∟ | 1.40 | 1.78 | 1.59 | | | |
| L3 | 0.88 | 1.27 | 1.08 | | | |
| L4 | 0.64 | 1.02 | 0.83 | | | |
| а | 0° | 10° | - | | | |
| All | All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TO252 (DPAK)

| Dimensions | Value (in mm) | | | |
|------------|---------------|--|--|--|
| С | 4.572 | | | |
| Х | 1.060 | | | |
| X1 | 5.632 | | | |
| Y | 2.600 | | | |
| Y1 | 5.700 | | | |
| Y2 | 10.700 | | | |



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